

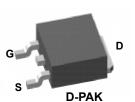
FDD5N50NZ N-Channel UniFETTM II MOSFET 500 V, 4 A, 1.5 Ω

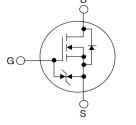
Features

- $R_{DS(on)}$ = 1.38 Ω (Typ.) @ V_{GS} = 10 V, I_D = 2 A
- Low Gate Charge (Typ. 9 nC)
- Low C_{rss} (Typ. 4 pF)
- 100% Avalanche Tested
- Improved dv/dt Capability
- · ESD Imoroved Capability
- RoHS Compliant

Applications

- LCD/LED/PDP TV
- Lighting
- Uninterruptible Power Supply





UniFETTM II MOSFET is Fairchild Semiconductor®'s high volt-

age MOSFET family based on advanced planar stripe and

DMOS technology. This advanced MOSFET family has the smallest on-state resistance among the planar MOSFET, and

also provides superior switching performance and higher ava-

lanche energy strength. In addition, internal gate-source ESD diode allows UniFET II MOSFET to withstand over 2kV HBM

surge stress. This device family is suitable for switching power converter applications such as power factor correction (PFC), flat

panel display (FPD) TV power, ATX and electronic lamp ballasts.

Description

MOSFET Maximum Ratings T_C = 25°C unless otherwise noted*

Thermal Resistance, Junction to Ambient, Max.

Symbol	Parameter		FDD5N50NZ	Unit	
V _{DSS}	Drain to Source Voltage		500	V	
V _{GSS}	Gate to Source Voltage		±25	V	
ID	Drain Current	- Continuous (T _C = 25 ^o C)		4	- A
		- Continuous (T _C = 100 ^o C)		2.4	
I _{DM}	Drain Current	- Pulsed	(Note 1)	16	A
E _{AS}	Single Pulsed Avalanche Energy (Note 2)		304	mJ	
I _{AR}	Avalanche Current (Note 1)		4	A	
E _{AR}	Repetitive Avalanche Energy (Note 1)		6.2	mJ	
dv/dt	Peak Diode Recovery dv/dt (Note 3		(Note 3)	10	V/ns
P _D	Power Dissipation	$(T_{\rm C} = 25^{\rm o}{\rm C})$		62	W
		- Derate above 25°C		0.5	W/ºC
T _J , T _{STG}	Operating and Storage Temperature Range		-55 to +150	°C	
TL	Maximum Lead Temperature for Soldering Purpose, 1/8" from Case for 5 Seconds			300	°C
	ited by maximum junction temperature				
Symbol	Parameter		FDD5N50NZ	Unit	
$R_{ ext{ heta}JC}$	Thermal Resistance, Junction to Case, Max.		2.0	°C/W	
P	Thermal Resistance Junction to Ambient Max			90	- C/VV

 $\mathsf{R}_{\theta\mathsf{J}\mathsf{A}}$

90

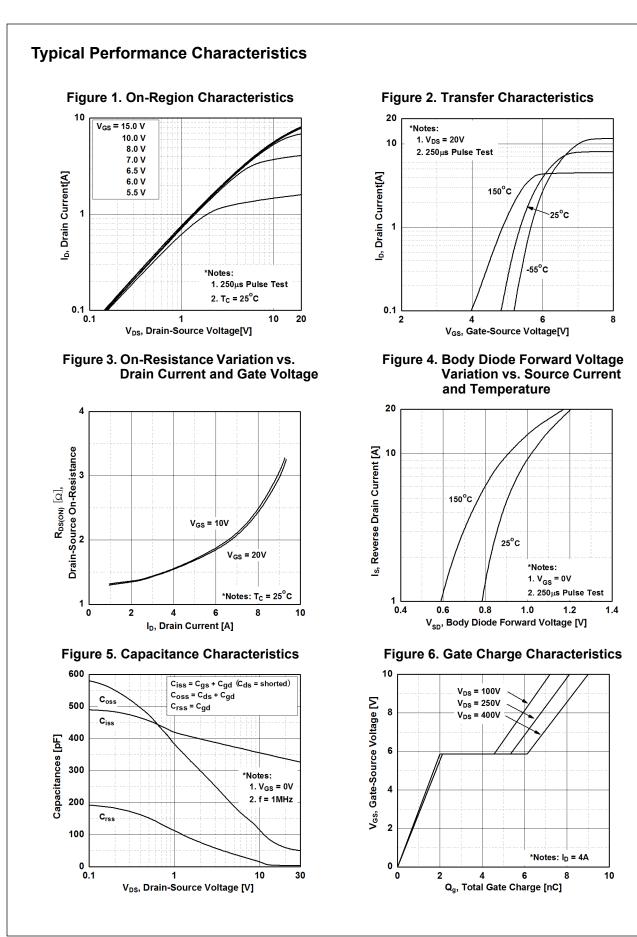
<u> </u>		Package	• •		e Width		Quantity		
		D-PAK			16mm		2500		
Electrica	l Chai	racteristics T _c =	25°C unless ot	herwise noted					
Symbol				Test Conditions		Min.	Тур.	Max.	Unit
Off Charac	teristic	S				I			
BV _{DSS}	Drain te	to Source Breakdown Voltage		I _D = 250μA, V _{GS} = 0V, T _J = 25 ^o C		500	-	-	V
ΔBV_{DSS} $\Delta T_{,l}$	Breakd	akdown Voltage Temperature		$I_D = 250 \mu$ A, Referenced to 25° C		-	0.5	-	V/°C
	7			$V_{DS} = 500V, V_{GS} = 0V$ $V_{DS} = 400V, T_{C} = 125^{\circ}C$		-	-	1	
I _{DSS} Zero Gate		ate Voltage Drain Curr	ent \			-	-	10	- μΑ
I _{GSS}	Gate to	Body Leakage Currer	۱t ۱	$V_{GS} = \pm 25 V, V_{DS} = 0 V$			-	±10	μA
On Charac	teristic	S							
V _{GS(th)}	Gate T	hreshold Voltage		V _{GS} = V _{DS} , I _D = 250μA			-	5.0	V
R _{DS(on)}		Drain to Source On Resistance		$V_{GS} = 10V, I_D = 2A$	-	1.38	1.5	Ω	
9 _{FS}	Forwar	d Transconductance		$V_{DS} = 20V, I_D = 2A$			3.54	-	S
C _{iss} C _{oss}	Output	apacitance Capacitance	f	V _{DS} = 25V, V _{GS} = 0V [™] = 1MHz	-	-	330 50 4	440 70 6	pF pF
C _{rss}		e Transfer Capacitanc	9			-	4 9	6 12	pF nC
Q _{g(tot)}		Gate Charge at 10V to Source Gate Charge to Drain "Miller" Charge		$V_{DS} = 400 V I_D = 4A$ $V_{GS} = 10V$ (Note 4)		-	2	12	nC
Q _{gs}						-	4	-	nC
Q _{gd}	Gale it					-	4	-	IIC
Switching	Charac	teristics							
t _{d(on)}	_	n Delay Time	,	V_{DD} = 250V, I_D = 4A V_{GS} = 10V, R_G = 25 Ω		-	12	35	ns
t _r		n Rise Time				-	22	55	ns
t _{d(off)}	_	ff Delay Time				-	28	65	ns
t _f	I urn-O	ff Fall Time			(Note 4)	-	21	50	ns
Drain-Sou		de Characteristic	-						
I _S	Maximum Continuous Drain to Source Diod					-	-	4	A
I _{SM}	-	Im Pulsed Drain to Sou				-	-	16	A
V _{SD}	-	Source Diode Forwar	-	/ _{GS} = 0V, I _{SD} = 4A		-	-	1.4	V
t _{rr} Q _{rr}	-	e Recovery Time		$V_{GS} = 0V, I_{SD} = 4A$		-	210	-	ns
()	Dovore	e Recovery Charge	C	dI _⊏ /dt = 100A/μs	(Note 4)	-	1.1	I -	μC

Notes: 1. Repetitive Rating: Pulse width limited by maximum junction temperature

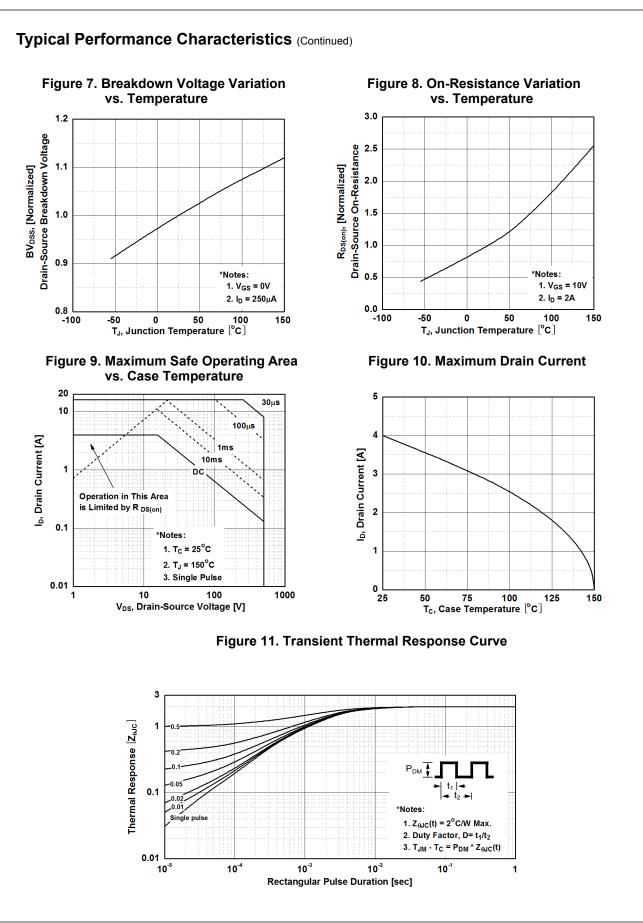
2. L = 38mH, I_{AS} = 4A, V_{DD} = 50V, R_G = 25 Ω , Starting T_J = 25°C

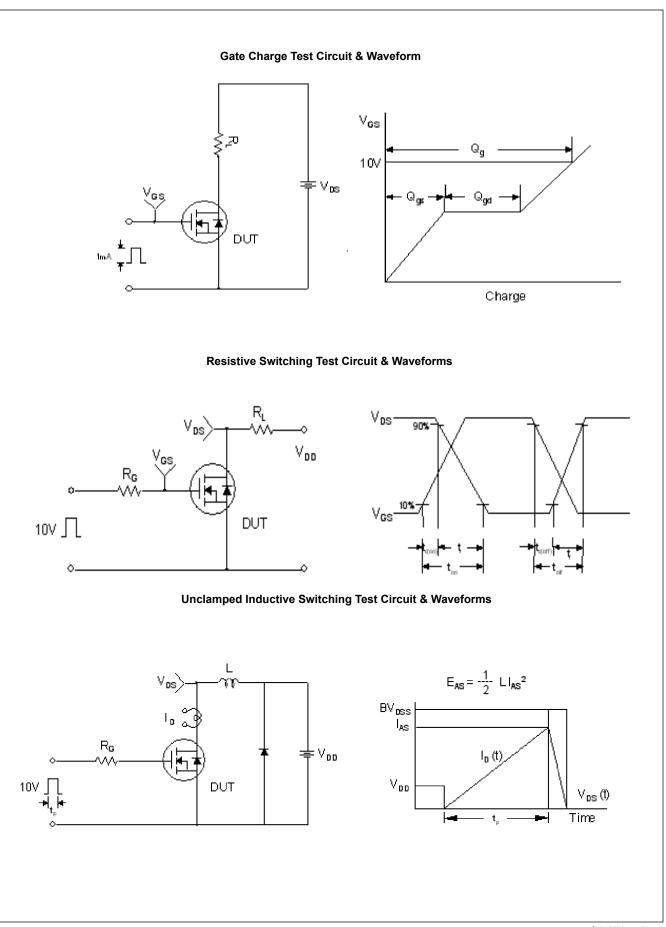
3. $I_{SD} \leq$ 4A, di/dt \leq 200A/µs, $V_{DD} \leq BV_{DSS},$ Starting T_J = 25°C

4. Essentially Independent of Operating Temperature Typical Characteristics



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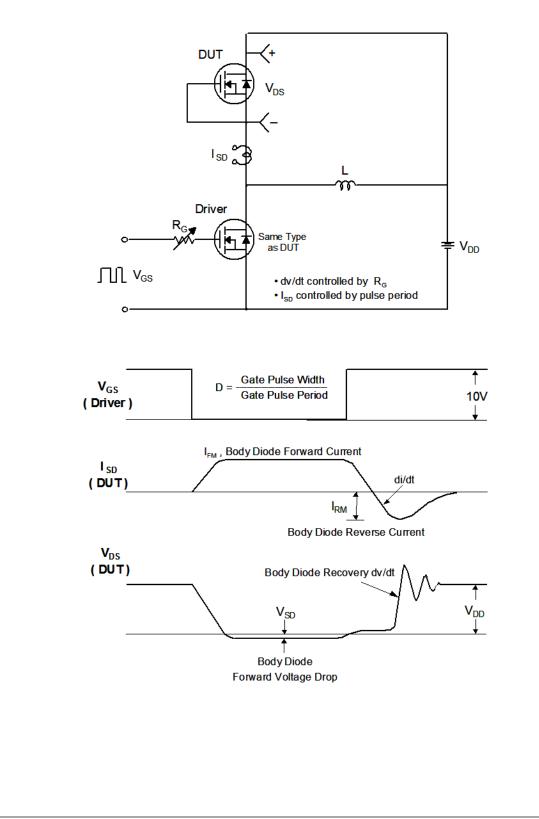


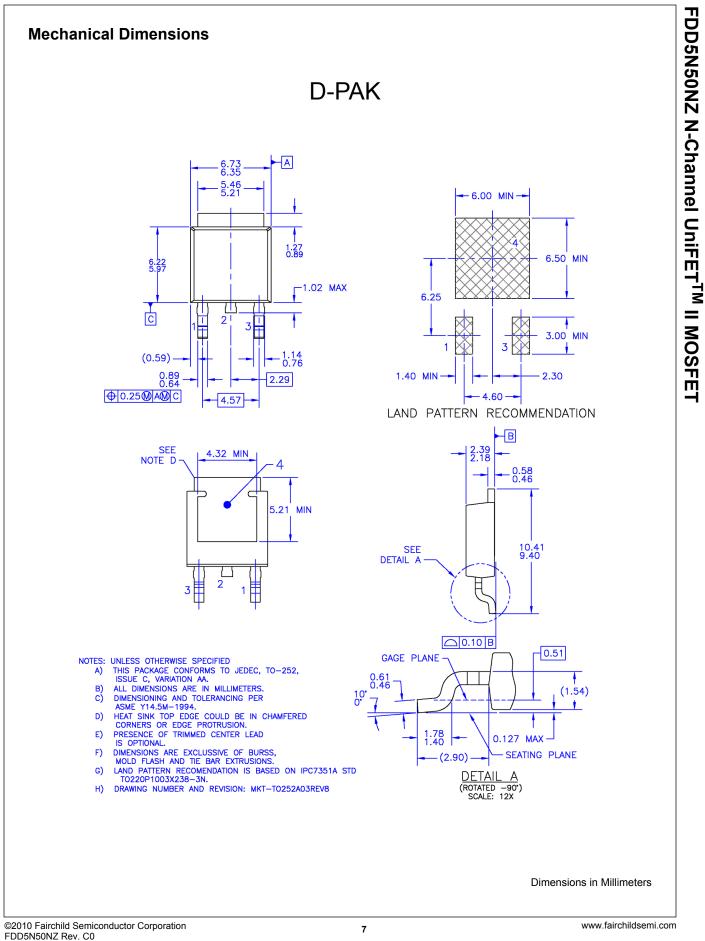


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